**AGENDA - Asian IBIS Summit (Shanghai)**

**Friday, November 1, 2019**

Parkyard Hotel

Shanghai, P.R. China

Room: **Ballroom ABC**

Sponsors: **Huawei Technologies (Primary)**

**ANSYS**

**Cadence Design Systems**

**Keysight Technologies**

**Synopsys**

**ZTE Corporation**

 *(Order and times subject to change)*

09:00 **SIGN IN**

* Vendor Tables Open at 9:00

09:30 **MEETING** **WELCOMES**

* Yan, Hang (Paul)
(Huawei Technologies, PRC)
* Wolff, Randy (Chair, IBIS Open Forum)
(Micron Technology, USA)

09:40 **IBIS Chair’s Report**

Wolff, Randy (Micron Technology, USA)

10:00 **How to Obtain Buffer Impedance from IBIS**

Wang, Lance (Zuken, USA)

10:20 **C-PHY SI Simulation with IBIS Model**

Zhang, Bailing (ANSYS, PRC)

10:35 **BREAK**

* Refreshments and Vendor Tables
* Reconvene at 10:55

10:55 **Innovations in DDR Memory Simulation**

Slater, Stephen (Keysight Technologies, USA)

*[Presented by Zhao, Jiajie (Keysight Technologies, PRC)]*

11:20 **IBIS-AMI and COM Co-design for 25G Serdes**

Hou\*, Nan; Zhang\*, Amy; Wang\*, Guohua; Zhang\*\*, David; Ekholm\*\*, Anders

(Ericsson, \*PRC, \*\*Sweden)

*[Presented by Hou, Nan (Ericsson, PRC)]*

12:00 **FREE LUNCH (hosted by sponsors)**

* Reconvene at 13:30

13:30 **How to Fix a Short Channel Problem with AMI and COM Simulation**

Ye, Dongdong; Zhu, Shunlin (ZTE Corporation, PRC)

*[Presented by Ye, Dongdong (ZTE Corporation, PRC)]*

14:00 **Celestica 112G SI Channel Study for 800G Switch**

Shi, Bowen; Feng, Sophia (Celestica, PRC)

*[Presented by Shi, Bowen (Celestica, PRC)]*

14:30 **Channel Simulation Over DDR4/5 and Above**

Keshavan\*, Kumar; Varma\*, Ambrish; Willis\*, Ken; Liang\*\*, Skipper

(Cadence Design Systems, \*USA, \*\*ROC)

*[Presented by Skipper Liang (Cadence Design Systems, ROC)]*

15:05 **CONCLUDING ITEMS**

15:10 **END OF IBIS SUMMIT MEETING**

* Thank you for your participation

15:10 **BREAK**

* Refreshments and Vendor Tables

15:30 **VENDOR PRESENTATIONS, MODERATOR**

Lance Wang (Vice-chair, IBIS Open Forum)

(Zuken, USA)

17:30 **END OF VENDOR PRESENTATIONS**

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